PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

Datasheet

Parameter	Value
V _{CEO}	-50V
I _C	-100mA
R	100kΩ

Features

- 1) Built-In Biasing Resistors, $R_1 = 100k\Omega$
- 2) Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see inner circuit).
- 3) Only the on/off conditions need to be set for operation, making the circuit design easy.
- 4) Complementary NPN Types: DTC115T series

Outline

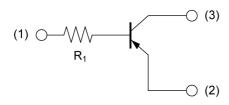
SOT-723	SOT-323
(1)	(2)
DTA115TM (VMT3)	DTA115TUA (UMT3)

Application

INVERTER, INTERFACE, DRIVER

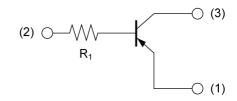
•Inner circuit

DTA115TM



- (1) BASE
- (2) EMITTER
- (3) COLLECTOR

DTA115TUA



- (1) EMITTER
- (2) BASE
- (3) COLLECTOR

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
DTA115TM	SOT-723 (VMT3)	1212	T2L	180	8	8000	99
DTA115TUA	SOT-323 (UMT3)	2021	T106	180	8	3000	99

● Absolute maximum ratings (T_a = 25°C)

Parameter			Values	Unit
Collector-base voltage			-50	V
Collector-emitter voltage			-50	V
Emitter-base voltage			-5	V
Collector current		I _C *1	-100	mA
Power dissipation DTA115TM DTA115TUA		D *2	150	2010/
		P_D^{*2}	200	mW
Junction temperature		T _j	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C

● Electrical characteristics (T_a = 25°C)

Darameter	Cymahal	Conditions	Values			Lloit
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit
Collector-base breakdown voltage	BV _{CBO}	I _C = -50μA	-50	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = -1mA	-50	-	-	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = -50μA	-5	-	-	V
Collector cut-off current	I _{CBO}	V _{CB} = -50V	-	-	-500	nA
Emitter cut-off current	I _{EBO}	V _{EB} = -4V	-	-	-500	nA
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = -1mA, I _B = -0.1mA	-	-	-300	mV
DC current gain	h _{FE}	$V_{CE} = -5V$, $I_C = -1mA$	100	250	600	-
Input resistance	R ₁	-	70	100	130	kΩ
Transition frequency	f _T *1	V _{CE} = -10V, I _E = 5mA, f = 100MHz	-	250	-	MHz

^{*1} Characteristics of built-in transistor

^{*2} Each terminal mounted on a reference land.

● Electrical characteristic curves (T_a =25°C)

Fig.1 Grounded emitter propagation characteristics

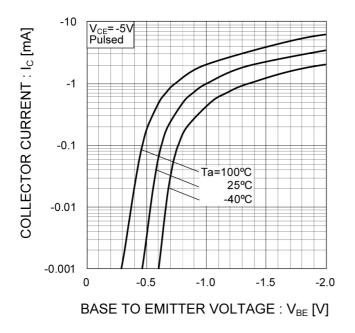
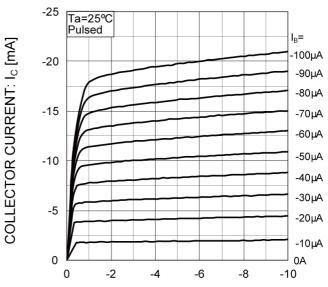


Fig.2 Grounded emitter output characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current gain vs. Collector Current

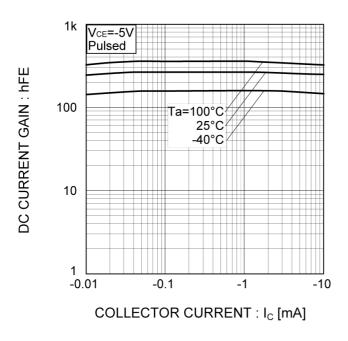
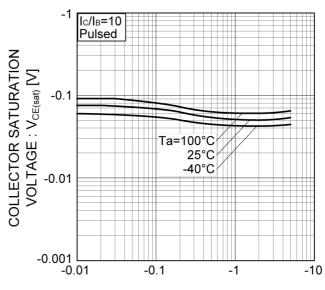
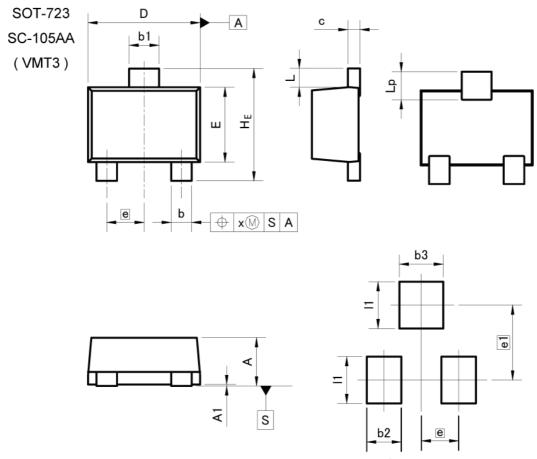


Fig.4 Collector-emitter saturation voltage vs. Collector Current



COLLECTOR CURRENT : I_C [mA]

Dimensions



Pattern of terminal	position areas
[Not a pattern of s	soldering pads]

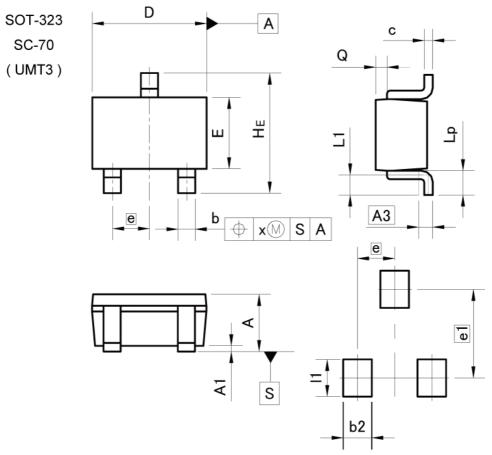
DIM	DIM MILIMETERS MIN MAX		INC	HES
DIM			MIN	MAX
Α	0.45	0.55	0.018	0.022
A1	0.00	0.10	0.000	0.004
b	0.17	0.27	0.007	0.011
b1	0.27	0.37	0.011	0.015
С	0.08	0.18	0.003	0.007
D	1.10	1.30	0.043	0.051
E	0.70	0.90	0.028	0.035
е	0.4	40	0.0	02
HE	1.10	1.30	0.043	0.051
L	0.10	0.30	0.004	0.012
Lp	0.20	0.40	0.008	0.016
х	_	0.10	_	0.004

DIM	MILIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
b2	-	0.37	_	0.015
b3	_	0.47	7-	0.019
e1	0.80		0.0	31
11	=	0.50		0.020

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.5	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	0.65 0.026		26
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	-	0.10	-	0.004

DIM MILIMETERS		INCHES		
DIM	MIN MAX		MIN	MAX
b2	_	0.50	_	0.020
e1	1.55		0.0	61
- 11	-	0.65	-	0.026

Dimension in mm/inches



Notice

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JAPAN	USA	EU	CHINA
CLASSⅢ	CLACCIII	CLASS II b	CL ACCIII
CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
 may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
 exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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